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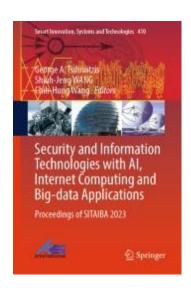
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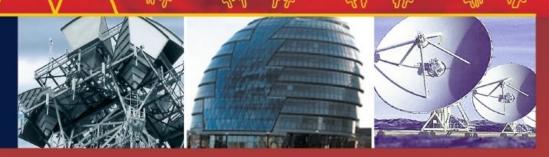
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Editors
George A. Tsihrintzis
Department of Informatics
University of Piraeus
Piraeus, Greece

Chih-Hung Wang Department of Computer Science and Information Engineering National Chiayi University Chiayi, Taiwan Shiuh-Jeng WANG
Department of Information Management
Central Police University
Taoyuan City, Taiwan

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